

SEA & LAND ELECTRONIC CORP.

www.sealand-pptc.com

APPROVAL SHEET

MODEL NO.:	nSMD075-16V	
CUSTOMER:	_	
COSTOWER:		
CUSTOMER'S APPRO	OVAL:	
	- · · · - ·	
AUTHORIZED SIGNA	TURE/STAMP.	
NOTHORIZED GIGINA	TORE/OT/WIII .	
DATE		
MANUFACTURER:		
HEAD OFFICE:	13F.,No.120-10,Sec.3,Zhongshan Rd.,Zhonghe Dist.,New Ta	ninai City 23544 Taiwan
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Approved by: YC Lin
DATE: 2014/12/25

SEA & LAND ELECTRONIC CORP.



nSMD075-16V

Features

- Surface Mount Devices
- Lead free device
- Size 3.2*1.6 mm/0.12*0.06 inch
- Surface Mount packaging for automated assembly

Application

protected, including:

Almost anywhere there is a low voltage power supply, up to 60V and a load to be

- Computer mother board, Modern. USB hub
- PDAs & Charger, Analog & digital line card
- Digital cameras, Disk drivers, CD-ROMs,

Performance Specification

Model	Marking	V_{max}	I _{max}	Maximum I _{max} I _{hold} I _{trip} P _d Time To Trip			Resis	stance	Agency A	Approval		
Wodei	Marking			@25°C	@25°C	Max.	Current	Time	Ri_{min}	R1max	UL	TUV
		(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)	OL	101
nSMD075-16V	αG	16.0	100	0.75	1.50	0.6	8.00	0.20	0.090	0.500		

Ihold = Hold Current. Maximum current device will not trip in 25°C still air.

Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).

Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).

Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.

R1_{max} = Maximum device resistance is measured one hour post reflow.

CAUTION: Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H., 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202,Method 215	No change
Vibration	MIL-STD-202,Method 201	No change
Ambient operating conditions :	- 40 °C to 85 °C	
Maximum surface temperature of the co	levice in the tripped state is 125 °C	

Agency Approvals : UL pending

Regulation/Standard: (PS) RoHS 2002/95/EC

HF EN14582

I_{hold} Versus Temperature

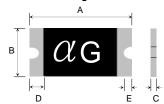
thold versus reini	Jerature								
Model	Maximum ambient operating temperature (T _{mao}) vs. hold current (I _{hold})								
Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
nSMD075-16	/ 11/	1.01	0.88	0.75	0.65	0.50	0.54	0.40	0.41

nSMD075-16V

Construction And Dimension (Unit:mm)

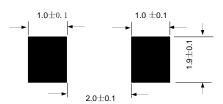
Model	,	A		В			D	E
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
nSMD075-16V	3.00	3.50	1.50	1.80	0.50	1.20	0.15	0.10

Dimensions & Marking



α = Trademark G = Part identification

Recommended Pad Layout (mm)



Termination Pad Characteristics

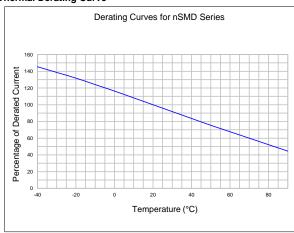
Tin-plated Nickel-Copper Terminal pad materials:

Terminal pad solderability: Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

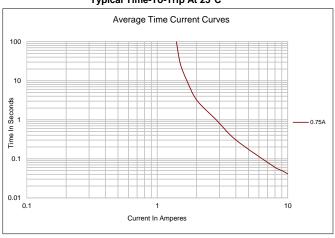
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve



Typical Time-To-Trip At 25°C



WARNING:

- Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

 PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.

 Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

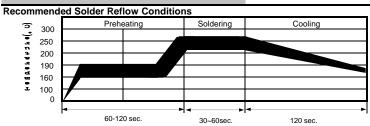
 Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

 Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.

 Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.

 Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

nSMD075-16V

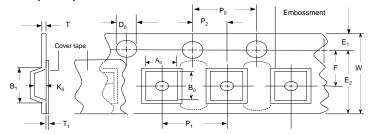


- · Recommended reflow methods: IR, vapor phase oven, hot air oven.
- Devices are not designed to be wave soldered to the bottom side
- of the board.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard method and solvents.
- Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

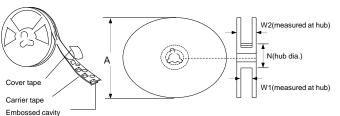
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	8.15 ± 0.3
P0	4.0 ± 0.10
P1	4.0 ± 0.10
P2	2.0 ± 0.05
A0	1.95 ± 0.10
B0	3.45 ± 0.10
B1max.	4.35
D0	1.5 + 0.1, -0
F	3.5 ± 0.05
E1	1.75 ± 0.10
E2min.	6.25
Tmax.	0.6
T1max.	0.1
K0	1.04 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	9 ± 0.5
W2	12.6 ± 0.5
	

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

Order Information Packaging nSMD 075 -16V Tape & Reel Quantity Product name Hold Max Size 3216 mm / 1206 inch Current Voltage 3500 pcs/reel SMD: surface mount device 0.75A 3500 pcs/reel

Tape & reel packaging per EIA481-1

Labeling Information

